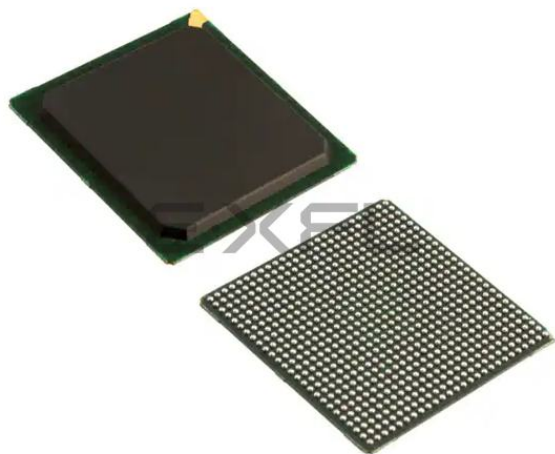




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Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	2688
Number of Logic Elements/Cells	-
Total RAM Bits	1032192
Number of I/O	456
Number of Gates	2000000
Voltage - Supply	1.425V ~ 1.575V
Mounting Type	Surface Mount
Operating Temperature	-40°C ~ 100°C (TJ)
Package / Case	676-BGA
Supplier Device Package	676-FBGA (27x27)
Purchase URL	https://www.e-xfl.com/product-detail/xilinx/xc2v2000-5fgg676i

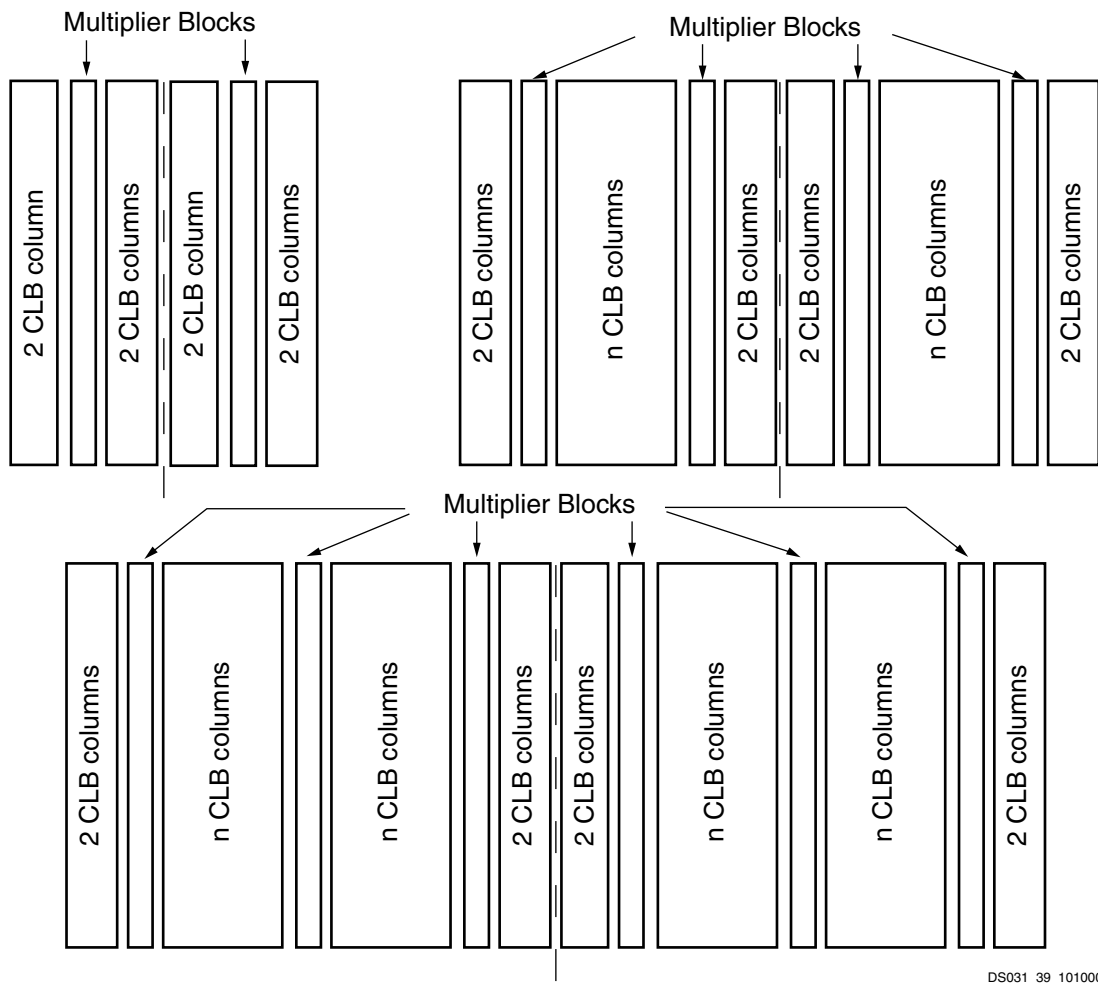


Figure 37: Multipliers (2-column, 4-column, and 6-column)

Global Clock Multiplexer Buffers

Virtex-II devices have 16 clock input pins that can also be used as regular user I/Os. Eight clock pads are on the top edge of the device, in the middle of the array, and eight are on the bottom edge, as illustrated in Figure 38.

The global clock multiplexer buffer represents the input to dedicated low-skew clock tree distribution in Virtex-II devices. Like the clock pads, eight global clock multiplexer buffers are on the top edge of the device and eight are on the bottom edge.

Each global clock buffer can either be driven by the clock pad to distribute a clock directly to the device, or driven by the Digital Clock Manager (DCM), discussed in [Digital Clock Manager \(DCM\)](#), page 29. Each global clock buffer can also be driven by local interconnects. The DCM has clock output(s) that can be connected to global clock buffer inputs, as shown in Figure 39.

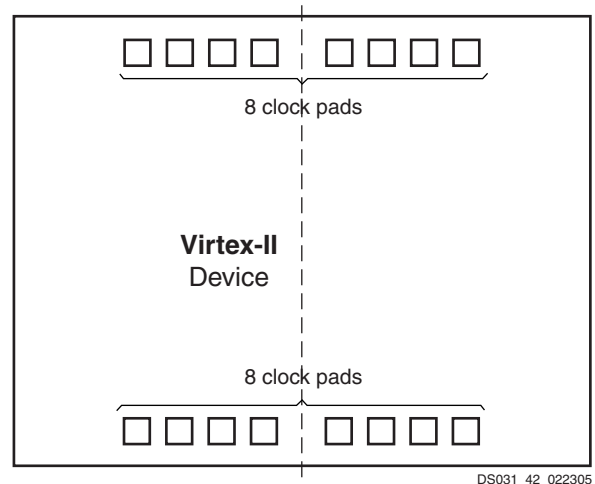


Figure 38: Virtex-II Clock Pads

I/O Standard Adjustment Measurement Methodology

Input Delay Measurements

Table 18 shows the test setup parameters used for measuring Input standard adjustments (see Table 15, page 11).

Table 18: Input Delay Measurement Methodology

Description	IOSTANDARD Attribute	$V_L^{(1,2)}$	$V_H^{(1,2)}$	$V_{MEAS}^{(1,4,5)}$	$V_{REF}^{(1,3,5)}$
LVTTL (Low-Voltage Transistor-Transistor Logic)	LVTTL	0	3.0	1.4	–
LVC MOS (Low-Voltage CMOS), 3.3V	LVC MOS33	0	3.3	1.65	–
LVC MOS, 2.5V	LVC MOS25	0	2.5	1.25	–
LVC MOS, 1.8V	LVC MOS18	0	1.8	0.9	–
LVC MOS, 1.5V	LVC MOS15	0	1.5	0.75	–
PCI (Peripheral Component Interface), 33 MHz, 3.3V	PCI33_3	Per PCI Specification			–
PCI, 66 MHz, 3.3V	PCI66_3	Per PCI Specification			–
PCI-X, 133 MHz, 3.3V	PCIX	Per PCI-X Specification			–
GTL (Gunning Transceiver Logic)	GTL	$V_{REF} - 0.2$	$V_{REF} + 0.2$	V_{REF}	0.80
GTL Plus	GTL P	$V_{REF} - 0.2$	$V_{REF} + 0.2$	V_{REF}	1.0
HSTL (High-Speed Transceiver Logic), Class I & II	HSTL_I, HSTL_II	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.75
HSTL, Class III & IV	HSTL_III, HSTL_IV	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
HSTL, Class I & II, 1.8V	HSTL_I_18, HSTL_II_18	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
HSTL, Class III & IV, 1.8V	HSTL_III_18, HSTL_IV_18	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	1.08
SSTL (Stub Terminated Transceiver Logic), Class I & II, 3.3V	SSTL3_I, SSTL3_II	$V_{REF} - 1.00$	$V_{REF} + 1.00$	V_{REF}	1.5
SSTL, Class I & II, 2.5V	SSTL2_I, SSTL2_II	$V_{REF} - 0.75$	$V_{REF} + 0.75$	V_{REF}	1.25
SSTL, Class I & II, 1.8V	SSTL18_I, SSTL18_II	$V_{REF} - 0.5$	$V_{REF} + 0.5$	V_{REF}	0.90
AGP-2X/AGP (Accelerated Graphics Port)	AGP	$V_{REF} - (0.2 \times V_{CCO})$	$V_{REF} + (0.2 \times V_{CCO})$	V_{REF}	AGP Spec
LVDS (Low-Voltage Differential Signaling), 2.5V	LVDS_25	$1.2 - 0.125$	$1.2 + 0.125$	1.2	
LVDS, 3.3V	LVDS_33	$1.2 - 0.125$	$1.2 + 0.125$	1.2	
LVDSEXT (LVDS Extended Mode), 2.5V	LVDSEXT_25	$1.2 - 0.125$	$1.2 + 0.125$	1.2	
LVDSEXT, 3.3V	LVDSEXT_33	$1.2 - 0.125$	$1.2 + 0.125$	1.2	
ULVDS (Ultra LVDS), 2.5V	ULVDS_25	$0.6 - 0.125$	$0.6 + 0.125$	0.6	
LDT (HyperTransport), 2.5V	LDT_25	$0.6 - 0.125$	$0.6 + 0.125$	0.6	
LVPECL (Low-Voltage Positive Electron-Coupled Logic), 3.3V	LVPECL_33	$1.6 - 0.3$	$1.6 + 0.3$	1.6	

Notes:

1. Input delay measurement methodology parameters for LVDCI and HSLVDCI are the same as for LVC MOS standards of the same voltage. Parameters for all other DCI standards are the same as for the corresponding non-DCI standards.
2. Input waveform switches between V_L and V_H .
3. Measurements are made at typical, minimum, and maximum V_{REF} values. Reported delays reflect worst case of these measurements. V_{REF} values listed are typical. See [Virtex-II Platform FPGA User Guide](#) for min/max specifications.
4. Input voltage level from which measurement starts.
5. Note that this is an input voltage reference that bears no relation to the V_{REF} / V_{MEAS} parameters found in IBIS models and/or noted in Figure 1.

Enhanced Multiplier Switching Characteristics

Table 26 and Table 27 provide timing information for enhanced Virtex-II multiplier blocks, available in stepping revisions of Virtex-II devices. For more information on stepping revisions, availability, and ordering instructions, see your local sales representative.

Table 26: Enhanced Multiplier Switching Characteristics

Description	Symbol	Speed Grade			Units
		-6	-5	-4	
Propagation Delay to Output Pin					
Input to Pin 35	T _{MULT1_P35}	4.66	5.14	5.91	ns, Max
Input to Pin 34	T _{MULT1_P34}	4.57	5.03	5.79	ns, Max
Input to Pin 33	T _{MULT1_P33}	4.47	4.93	5.66	ns, Max
Input to Pin 32	T _{MULT1_P32}	4.37	4.82	5.54	ns, Max
Input to Pin 31	T _{MULT1_P31}	4.28	4.71	5.42	ns, Max
Input to Pin 30	T _{MULT1_P30}	4.18	4.61	5.29	ns, Max
Input to Pin 29	T _{MULT1_P29}	4.08	4.50	5.17	ns, Max
Input to Pin 28	T _{MULT1_P28}	3.99	4.39	5.05	ns, Max
Input to Pin 27	T _{MULT1_P27}	3.89	4.28	4.92	ns, Max
Input to Pin 26	T _{MULT1_P26}	3.79	4.18	4.80	ns, Max
Input to Pin 25	T _{MULT1_P25}	3.69	4.07	4.68	ns, Max
Input to Pin 24	T _{MULT1_P24}	3.60	3.96	4.56	ns, Max
Input to Pin 23	T _{MULT1_P23}	3.50	3.86	4.43	ns, Max
Input to Pin 22	T _{MULT1_P22}	3.40	3.75	4.31	ns, Max
Input to Pin 21	T _{MULT1_P21}	3.31	3.64	4.19	ns, Max
Input to Pin 20	T _{MULT1_P20}	3.21	3.54	4.06	ns, Max
Input to Pin 19	T _{MULT1_P19}	3.11	3.43	3.94	ns, Max
Input to Pin 18	T _{MULT1_P18}	3.02	3.32	3.82	ns, Max
Input to Pin 17	T _{MULT1_P17}	2.92	3.21	3.69	ns, Max
Input to Pin 16	T _{MULT1_P16}	2.82	3.11	3.57	ns, Max
Input to Pin 15	T _{MULT1_P15}	2.72	3.00	3.45	ns, Max
Input to Pin 14	T _{MULT1_P14}	2.63	2.89	3.33	ns, Max
Input to Pin 13	T _{MULT1_P13}	2.53	2.79	3.20	ns, Max
Input to Pin 12	T _{MULT1_P12}	2.43	2.68	3.08	ns, Max
Input to Pin 11	T _{MULT1_P11}	2.34	2.57	2.96	ns, Max
Input to Pin 10	T _{MULT1_P10}	2.24	2.47	2.83	ns, Max
Input to Pin 9	T _{MULT1_P9}	2.14	2.36	2.71	ns, Max
Input to Pin 8	T _{MULT1_P8}	2.05	2.25	2.59	ns, Max
Input to Pin 7	T _{MULT1_P7}	1.95	2.14	2.46	ns, Max
Input to Pin 6	T _{MULT1_P6}	1.85	2.04	2.34	ns, Max
Input to Pin 5	T _{MULT1_P5}	1.75	1.93	2.22	ns, Max
Input to Pin 4	T _{MULT1_P4}	1.66	1.82	2.10	ns, Max
Input to Pin 3	T _{MULT1_P3}	1.56	1.72	1.97	ns, Max
Input to Pin 2	T _{MULT1_P2}	1.46	1.61	1.85	ns, Max
Input to Pin 1	T _{MULT1_P1}	1.37	1.50	1.73	ns, Max
Input to Pin 0	T _{MULT1_P0}	1.27	1.40	1.60	ns, Max

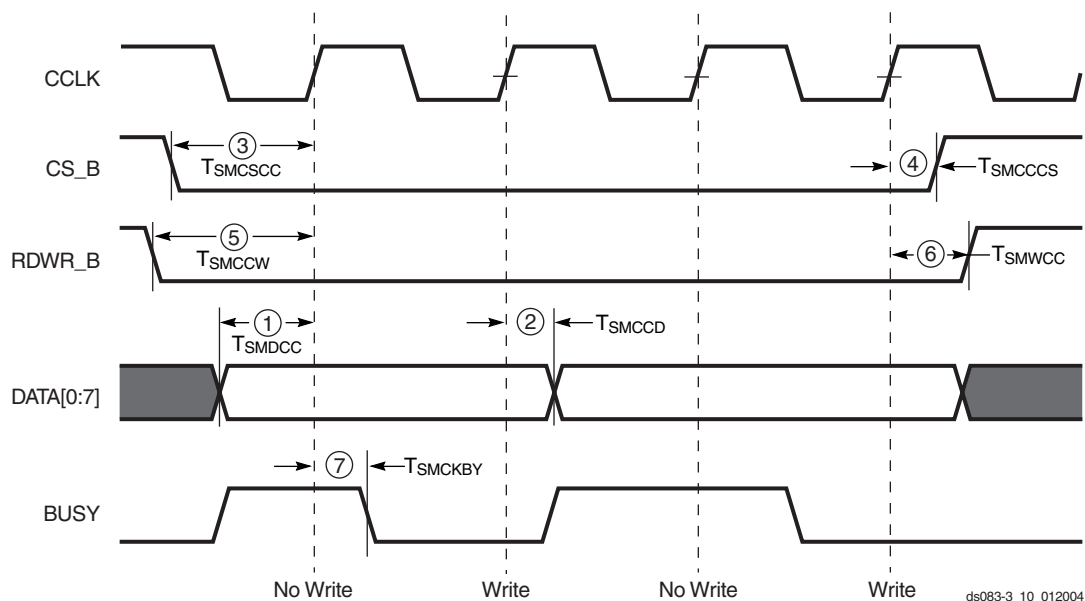


Figure 5: SelectMAP Mode Data Loading Sequence (Generic)

Table 32: SelectMAP Mode Write Timing Characteristics

	Description	Figure References	Symbol	Value	Units
CCLK	DATA[0:7] setup/hold	1/2	T_{SMDCD}/T_{SMCCD}	5.0/0.0	ns, min
	CS_B setup/hold	3/4	T_{SMCSCC}/T_{SMCCCS}	7.0/0.0	ns, min
	RDWR_B setup/hold	5/6	T_{SMCCW}/T_{SMWCC}	7.0/0.0	ns, min
	BUSY propagation delay	7	T_{SMCKBY}	12.0	ns, max
	Maximum start-up frequency		$F_{CC_STARTUP}$	50	MHz, max
	Maximum frequency		$F_{CC_SELECTMAP}$	50	MHz, max
	Maximum frequency with no handshake		F_{CCNH}	50	MHz, max

Table 6: FG256/FGG256 BGA — XC2V40, XC2V80, XC2V250, XC2V500, and XC2V1000

Bank	Pin Description	Pin Number	No Connect in XC2V40	No Connect in XC2V80
1	IO_L92P_1	E11	NC	NC
1	IO_L05N_1	A11	NC	NC
1	IO_L05P_1	B11	NC	NC
1	IO_L04N_1	C11	NC	NC
1	IO_L04P_1/VREF_1	D11	NC	NC
1	IO_L03N_1/VRP_1	A12		
1	IO_L03P_1/VRN_1	B12		
1	IO_L02N_1	C12		
1	IO_L02P_1	D12		
1	IO_L01N_1	B13		
1	IO_L01P_1	C13		
2	IO_L01N_2	C16		
2	IO_L01P_2	D16		
2	IO_L02N_2/VRP_2	D14		
2	IO_L02P_2/VRN_2	D15		
2	IO_L03N_2	E13		
2	IO_L03P_2/VREF_2	E14		
2	IO_L04N_2	E15	NC	
2	IO_L04P_2	E16	NC	
2	IO_L06N_2	F13	NC	
2	IO_L06P_2	F14	NC	
2	IO_L43N_2	F15	NC	NC
2	IO_L43P_2	F16	NC	NC
2	IO_L45N_2	F12	NC	NC
2	IO_L45P_2/VREF_2	G12	NC	NC
2	IO_L91N_2	G13	NC	
2	IO_L91P_2	G14	NC	
2	IO_L93N_2	G15	NC	
2	IO_L93P_2/VREF_2	G16	NC	
2	IO_L94N_2	H13		
2	IO_L94P_2	H14		
2	IO_L96N_2	H15		
2	IO_L96P_2	H16		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
5	IO_L02P_5/D7	AC6		
5	IO_L01N_5/RDWR_B	AB6		
5	IO_L01P_5/CS_B	AC5		
6	IO_L01P_6	AF2		
6	IO_L01N_6	AE1		
6	IO_L02P_6/VRN_6	AB4		
6	IO_L02N_6/VRP_6	AB3		
6	IO_L03P_6	AD2		
6	IO_L03N_6/VREF_6	AD1		
6	IO_L04P_6	AC2		
6	IO_L04N_6	AC1		
6	IO_L06P_6	AB2		
6	IO_L06N_6	AB1		
6	IO_L19P_6	AA4		
6	IO_L19N_6	AA3		
6	IO_L21P_6	Y6		
6	IO_L21N_6/VREF_6	Y5		
6	IO_L22P_6	W6		
6	IO_L22N_6	W7		
6	IO_L24P_6	AA2		
6	IO_L24N_6	AA1		
6	IO_L25P_6	Y4	NC	NC
6	IO_L25N_6	Y3	NC	NC
6	IO_L43P_6	W5		
6	IO_L43N_6	W4		
6	IO_L45P_6	W2		
6	IO_L45N_6/VREF_6	W3		
6	IO_L46P_6	Y1		
6	IO_L46N_6	W1		
6	IO_L48P_6	V6		
6	IO_L48N_6	V7		
6	IO_L49P_6	V5		
6	IO_L49N_6	V4		
6	IO_L51P_6	V3		
6	IO_L51N_6/VREF_6	V2		
6	IO_L52P_6	V1		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
NA	VCCINT	H19		
NA	VCCINT	H8		
NA	GND	AF26		
NA	GND	AF1		
NA	GND	AE25		
NA	GND	AE14		
NA	GND	AE13		
NA	GND	AE2		
NA	GND	AD24		
NA	GND	AD3		
NA	GND	AC23		
NA	GND	AC4		
NA	GND	AB22		
NA	GND	AB5		
NA	GND	AA21		
NA	GND	AA6		
NA	GND	U17		
NA	GND	U16		
NA	GND	U15		
NA	GND	U14		
NA	GND	U13		
NA	GND	U12		
NA	GND	U11		
NA	GND	U10		
NA	GND	T17		
NA	GND	T16		
NA	GND	T15		
NA	GND	T14		
NA	GND	T13		
NA	GND	T12		
NA	GND	T11		
NA	GND	T10		
NA	GND	R17		
NA	GND	R16		
NA	GND	R15		
NA	GND	R14		
NA	GND	R13		

Table 8: FG676/FGG676 BGA — XC2V1500, XC2V2000, and XC2V3000

Bank	Pin Description	Pin Number	No Connect in XC2V1500	No Connect in XC2V2000
NA	GND	L11		
NA	GND	L10		
NA	GND	K17		
NA	GND	K16		
NA	GND	K15		
NA	GND	K14		
NA	GND	K13		
NA	GND	K12		
NA	GND	K11		
NA	GND	K10		
NA	GND	F21		
NA	GND	F6		
NA	GND	E22		
NA	GND	E5		
NA	GND	D23		
NA	GND	D4		
NA	GND	C24		
NA	GND	C3		
NA	GND	B25		
NA	GND	B14		
NA	GND	B13		
NA	GND	B2		
NA	GND	A26		
NA	GND	A1		

Notes:

1. See Table 4 for an explanation of the signals available on this pin.

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
1	IO_L27N_1/VREF_1	F19
1	IO_L27P_1	G19
1	IO_L25N_1	J19
1	IO_L25P_1	J20
1	IO_L24N_1	C20
1	IO_L24P_1	C21
1	IO_L22N_1	D20
1	IO_L22P_1	E21
1	IO_L21N_1/VREF_1	E20
1	IO_L21P_1	F20
1	IO_L19N_1	A21
1	IO_L19P_1	B21
1	IO_L06N_1	A22
1	IO_L06P_1	B22
1	IO_L05N_1	C22
1	IO_L05P_1	C23
1	IO_L04N_1	D22
1	IO_L04P_1/VREF_1	E22
1	IO_L03N_1/VRP_1	A23
1	IO_L03P_1/VRN_1	B23
1	IO_L02N_1	A24
1	IO_L02P_1	B24
1	IO_L01N_1	A25
1	IO_L01P_1	B25
2	IO_L01N_2	C27
2	IO_L01P_2	D27
2	IO_L02N_2/VRP_2	D25
2	IO_L02P_2/VRN_2	D26
2	IO_L03N_2	E24
2	IO_L03P_2/VREF_2	E25
2	IO_L04N_2	E26
2	IO_L04P_2	E27
2	IO_L06N_2	F23
2	IO_L06P_2	F24
2	IO_L19N_2	F25

Table 10: BG728 BGA — XC2V3000

Bank	Pin Description	Pin Number
2	IO_L70P_2	N19
2	IO_L72N_2	M22
2	IO_L72P_2	M23
2	IO_L73N_2	M24
2	IO_L73P_2	N24
2	IO_L75N_2	M26
2	IO_L75P_2/VREF_2	M27
2	IO_L76N_2	N20
2	IO_L76P_2	N21
2	IO_L78N_2	N22
2	IO_L78P_2	N23
2	IO_L91N_2	N25
2	IO_L91P_2	P25
2	IO_L93N_2	N26
2	IO_L93P_2/VREF_2	N27
2	IO_L94N_2	P20
2	IO_L94P_2	P21
2	IO_L96N_2	P22
2	IO_L96P_2	P23
3	IO_L96N_3	R27
3	IO_L96P_3	R26
3	IO_L94N_3	R25
3	IO_L94P_3	R24
3	IO_L93N_3/VREF_3	R23
3	IO_L93P_3	T23
3	IO_L91N_3	R22
3	IO_L91P_3	R21
3	IO_L78N_3	R20
3	IO_L78P_3	R19
3	IO_L76N_3	T27
3	IO_L76P_3	T26
3	IO_L75N_3/VREF_3	T24
3	IO_L75P_3	U24
3	IO_L73N_3	T22
3	IO_L73P_3	U22

Table 11: FF896 BGA — XC2V1000, XC2V1500, and XC2V2000

Bank	Pin Description	Pin Number	No Connect in the XC2V1000	No Connect in the XC2V1500
NA	GND	T13		
NA	GND	T12		
NA	GND	R19		
NA	GND	R18		
NA	GND	R17		
NA	GND	R16		
NA	GND	R15		
NA	GND	R14		
NA	GND	R13		
NA	GND	R12		
NA	GND	P24		
NA	GND	P19		
NA	GND	P18		
NA	GND	P17		
NA	GND	P16		
NA	GND	P15		
NA	GND	P14		
NA	GND	P13		
NA	GND	P12		
NA	GND	P7		
NA	GND	N19		
NA	GND	N18		
NA	GND	N17		
NA	GND	N16		
NA	GND	N15		
NA	GND	N14		
NA	GND	N13		
NA	GND	N12		
NA	GND	M26		
NA	GND	M19		
NA	GND	M18		
NA	GND	M17		
NA	GND	M16		
NA	GND	M15		
NA	GND	M14		
NA	GND	M13		
NA	GND	M12		

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
7	IO_L45N_7	J34	
7	IO_L44P_7	M27	
7	IO_L44N_7	L27	
7	IO_L43P_7	H31	
7	IO_L43N_7	J31	
7	IO_L30P_7	F32	
7	IO_L30N_7	G32	
7	IO_L29P_7	N25	
7	IO_L29N_7	M25	
7	IO_L28P_7	F34	
7	IO_L28N_7	G34	
7	IO_L27P_7/VREF_7	J30	
7	IO_L27N_7	H30	
7	IO_L26P_7	K28	
7	IO_L26N_7	L28	
7	IO_L25P_7	H28	
7	IO_L25N_7	J29	
7	IO_L24P_7	G29	
7	IO_L24N_7	H29	
7	IO_L23P_7	L26	
7	IO_L23N_7	K26	
7	IO_L22P_7	F33	
7	IO_L22N_7	G33	
7	IO_L21P_7/VREF_7	J28	
7	IO_L21N_7	J27	
7	IO_L20P_7	K27	
7	IO_L20N_7	J26	
7	IO_L19P_7	E31	
7	IO_L19N_7	F31	
7	IO_L06P_7	D32	
7	IO_L06N_7	E32	
7	IO_L05P_7	L25	
7	IO_L05N_7	K24	
7	IO_L04P_7	D34	
7	IO_L04N_7	E34	
7	IO_L03P_7/VREF_7	G30	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
2	VCCO_2	R11	
2	VCCO_2	R5	
2	VCCO_2	P12	
2	VCCO_2	P11	
2	VCCO_2	N12	
2	VCCO_2	N11	
2	VCCO_2	M11	
2	VCCO_2	K1	
2	VCCO_2	G4	
3	VCCO_3	AH4	
3	VCCO_3	AE1	
3	VCCO_3	AC11	
3	VCCO_3	AB12	
3	VCCO_3	AB11	
3	VCCO_3	AA12	
3	VCCO_3	AA11	
3	VCCO_3	Y12	
3	VCCO_3	Y11	
3	VCCO_3	Y5	
3	VCCO_3	W12	
3	VCCO_3	W1	
3	VCCO_3	V12	
4	VCCO_4	AP16	
4	VCCO_4	AP10	
4	VCCO_4	AL7	
4	VCCO_4	AK15	
4	VCCO_4	AD15	
4	VCCO_4	AD14	
4	VCCO_4	AD13	
4	VCCO_4	AD12	
4	VCCO_4	AC17	
4	VCCO_4	AC16	
4	VCCO_4	AC15	
4	VCCO_4	AC14	
4	VCCO_4	AC13	
5	VCCO_5	AP25	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
5	VCCO_5	AP19	
5	VCCO_5	AL28	
5	VCCO_5	AK20	
5	VCCO_5	AD23	
5	VCCO_5	AD22	
5	VCCO_5	AD21	
5	VCCO_5	AD20	
5	VCCO_5	AC22	
5	VCCO_5	AC21	
5	VCCO_5	AC20	
5	VCCO_5	AC19	
5	VCCO_5	AC18	
6	VCCO_6	AH31	
6	VCCO_6	AE34	
6	VCCO_6	AC24	
6	VCCO_6	AB24	
6	VCCO_6	AB23	
6	VCCO_6	AA24	
6	VCCO_6	AA23	
6	VCCO_6	Y30	
6	VCCO_6	Y24	
6	VCCO_6	Y23	
6	VCCO_6	W34	
6	VCCO_6	W23	
6	VCCO_6	V23	
7	VCCO_7	U23	
7	VCCO_7	T34	
7	VCCO_7	T23	
7	VCCO_7	R30	
7	VCCO_7	R24	
7	VCCO_7	R23	
7	VCCO_7	P24	
7	VCCO_7	P23	
7	VCCO_7	N24	
7	VCCO_7	N23	
7	VCCO_7	M24	

Table 12: FF1152 BGA — XC2V3000, XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V3000
NA	GND	P20	
NA	GND	P19	
NA	GND	P18	
NA	GND	P17	
NA	GND	P16	
NA	GND	P15	
NA	GND	P14	
NA	GND	P7	
NA	GND	M30	
NA	GND	M5	
NA	GND	K32	
NA	GND	K3	
NA	GND	J19	
NA	GND	J16	
NA	GND	H34	
NA	GND	H27	
NA	GND	H8	
NA	GND	H1	
NA	GND	G28	
NA	GND	G21	
NA	GND	G14	
NA	GND	G7	
NA	GND	F29	
NA	GND	F6	
NA	GND	E30	
NA	GND	E23	
NA	GND	E12	
NA	GND	E5	
NA	GND	D31	
NA	GND	D4	
NA	GND	C34	
NA	GND	C32	
NA	GND	C25	
NA	GND	C10	
NA	GND	C3	
NA	GND	C1	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
1	IO_L09N_1/VREF_1	G9	NC	
1	IO_L09P_1	G10	NC	
1	IO_L08N_1	K13	NC	
1	IO_L08P_1	K12	NC	
1	IO_L07N_1	A4	NC	
1	IO_L07P_1	A5	NC	
1	IO_L06N_1	F8		
1	IO_L06P_1	E8		
1	IO_L05N_1	J11		
1	IO_L05P_1	K11		
1	IO_L04N_1	C5		
1	IO_L04P_1/VREF_1	C6		
1	IO_L03N_1/VRP_1	D6		
1	IO_L03P_1/VRN_1	D7		
1	IO_L02N_1	H10		
1	IO_L02P_1	J10		
1	IO_L01N_1	C4		
1	IO_L01P_1	B4		
2	IO_L01N_2	E3		
2	IO_L01P_2	D2		
2	IO_L02N_2/VRP_2	L13		
2	IO_L02P_2/VRN_2	M13		
2	IO_L03N_2	F4		
2	IO_L03P_2/VREF_2	E4		
2	IO_L04N_2	E1		
2	IO_L04P_2	D1		
2	IO_L05N_2	L12		
2	IO_L05P_2	M11		
2	IO_L06N_2	G6		
2	IO_L06P_2	F5		
2	IO_L07N_2	F2	NC	
2	IO_L07P_2	E2	NC	
2	IO_L08N_2	M12	NC	
2	IO_L08P_2	N12	NC	
2	IO_L09N_2	H6	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
3	IO_L10N_3	AK7	NC	
3	IO_L10P_3	AL7	NC	
3	IO_L09N_3/VREF_3	AK11	NC	
3	IO_L09P_3	AJ10	NC	
3	IO_L08N_3	AR1	NC	
3	IO_L08P_3	AT1	NC	
3	IO_L07N_3	AM5	NC	
3	IO_L07P_3	AN5	NC	
3	IO_L06N_3	AM7		
3	IO_L06P_3	AL8		
3	IO_L05N_3	AP3		
3	IO_L05P_3	AP4		
3	IO_L04N_3	AM6		
3	IO_L04P_3	AN6		
3	IO_L03N_3/VREF_3	AJ13		
3	IO_L03P_3	AH13		
3	IO_L02N_3/VRP_3	AR3		
3	IO_L02P_3/VRN_3	AT2		
3	IO_L01N_3	AP5		
3	IO_L01P_3	AR4		
4	IO_L01N_4/BUSY/DOU ⁽¹⁾	AV4		
4	IO_L01P_4/INIT_B	AU4		
4	IO_L02N_4/D0/DIN ⁽¹⁾	AM9		
4	IO_L02P_4/D1	AM10		
4	IO_L03N_4/D2/ALT_VRP_4	AT6		
4	IO_L03P_4/D3/ALT_VRN_4	AR6		
4	IO_L04N_4/VREF_4	AU6		
4	IO_L04P_4	AU5		
4	IO_L05N_4/VRP_4	AL10		
4	IO_L05P_4/VRN_4	AL11		
4	IO_L06N_4	AR8		
4	IO_L06P_4	AR7		
4	IO_L07N_4	AW5	NC	
4	IO_L07P_4	AW4	NC	
4	IO_L08N_4	AK12	NC	

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
5	IO_L55N_5	AV28		
5	IO_L55P_5	AV27		
5	IO_L54N_5	AP27		
5	IO_L54P_5	AP26		
5	IO_L53N_5	AN25		
5	IO_L53P_5	AN26		
5	IO_L52N_5	AU29		
5	IO_L52P_5	AU28		
5	IO_L51N_5/VREF_5	AR28		
5	IO_L51P_5	AR27		
5	IO_L50N_5	AJ24		
5	IO_L50P_5	AJ25		
5	IO_L49N_5	AW30		
5	IO_L49P_5	AW29		
5	IO_L36N_5	AT29	NC	
5	IO_L36P_5	AT28	NC	
5	IO_L35N_5	AK25	NC	
5	IO_L35P_5	AL26	NC	
5	IO_L34N_5	AV31	NC	
5	IO_L34P_5	AV30	NC	
5	IO_L33N_5/VREF_5	AP29	NC	
5	IO_L33P_5	AP28	NC	
5	IO_L32N_5	AK26	NC	
5	IO_L32P_5	AJ26	NC	
5	IO_L31N_5	AW32	NC	
5	IO_L31P_5	AW31	NC	
5	IO_L30N_5	AM27		
5	IO_L30P_5	AM26		
5	IO_L29N_5	AN28		
5	IO_L29P_5	AN29		
5	IO_L28N_5	AU31		
5	IO_L28P_5	AU30		
5	IO_L27N_5/VREF_5	AT31		
5	IO_L27P_5	AT30		
5	IO_L26N_5	AH25		
5	IO_L26P_5	AH26		

Table 13: FF1517 BGA — XC2V4000, XC2V6000, and XC2V8000

Bank	Pin Description	Pin Number	No Connect in the XC2V4000	No Connect in the XC2V6000
6	IO_L71N_6	AE39		
6	IO_L72P_6	AD36		
6	IO_L72N_6	AE36		
6	IO_L73P_6	AB29		
6	IO_L73N_6	AA29		
6	IO_L74P_6	AE38		
6	IO_L74N_6	AD38		
6	IO_L75P_6	AC33		
6	IO_L75N_6/VREF_6	AD33		
6	IO_L76P_6	AB30		
6	IO_L76N_6	AA30		
6	IO_L77P_6	AD37		
6	IO_L77N_6	AC37		
6	IO_L78P_6	AB34		
6	IO_L78N_6	AC34		
6	IO_L79P_6	AB31		
6	IO_L79N_6	AA31		
6	IO_L80P_6	AD39		
6	IO_L80N_6	AC39		
6	IO_L81P_6	AB35		
6	IO_L81N_6/VREF_6	AC35		
6	IO_L82P_6	AB32		
6	IO_L82N_6	AA32		
6	IO_L83P_6	AC38		
6	IO_L83N_6	AB38		
6	IO_L84P_6	AA33		
6	IO_L84N_6	AB33		
6	IO_L91P_6	Y28		
6	IO_L91N_6	Y29		
6	IO_L92P_6	AB39		
6	IO_L92N_6	AA39		
6	IO_L93P_6	AA36		
6	IO_L93N_6/VREF_6	AB36		
6	IO_L94P_6	Y31		
6	IO_L94N_6	Y32		
6	IO_L95P_6	AA37		

Table 14: BF957 — XC2V2000, XC2V3000, XC2V4000, and XC2V6000

Bank	Pin Description	Pin Number	No Connect in XC2V2000
1	IO_L21P_1	A4	
1	IO_L20N_1	G10	
1	IO_L20P_1	G9	
1	IO_L19N_1	B6	
1	IO_L19P_1	C5	
1	IO_L06N_1	C6	
1	IO_L06P_1	D6	
1	IO_L05N_1	H9	
1	IO_L05P_1	G8	
1	IO_L04N_1	D7	
1	IO_L04P_1/VREF_1	E6	
1	IO_L03N_1/VRP_1	E8	
1	IO_L03P_1/VRN_1	E7	
1	IO_L02N_1	F8	
1	IO_L02P_1	F7	
1	IO_L01N_1	B5	
1	IO_L01P_1	B3	
2	IO_L01N_2	F5	
2	IO_L01P_2	G4	
2	IO_L02N_2/VRP_2	G6	
2	IO_L02P_2/VRN_2	H6	
2	IO_L03N_2	D3	
2	IO_L03P_2/VREF_2	E4	
2	IO_L04N_2	K10	
2	IO_L04P_2	K9	
2	IO_L05N_2	D2	
2	IO_L05P_2	E3	
2	IO_L06N_2	F4	
2	IO_L06P_2	F3	
2	IO_L19N_2	L10	
2	IO_L19P_2	M10	
2	IO_L20N_2	H7	
2	IO_L20P_2	J8	
2	IO_L21N_2	D1	
2	IO_L21P_2/VREF_2	E1	
2	IO_L22N_2	G5	
2	IO_L22P_2	H5	